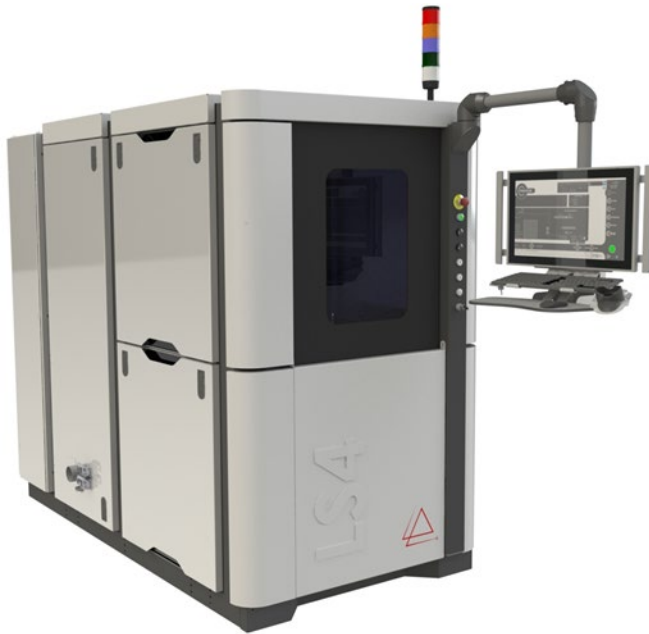


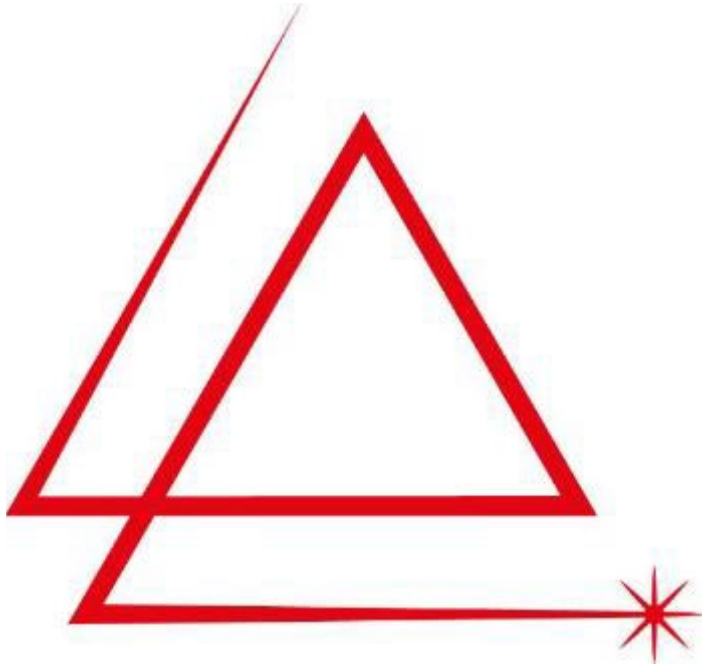
ENHANCING CONSUMER PRODUCT PERFORMANCE WITH ULTRAFAST LASER TECHNOLOGY

Céline Petit

Process Engineer, LASEA



SUMMARY



1. Introduction: Lasea Group
2. Laser machines
3. Future: AI predictions
4. Conclusion

1. INTRODUCTION: LASEA GROUP FACTS & FIGURES



8 500 sq.m.
production



+3 000
systems



+40
patents



5
continents



30 years
experience



15
app engineers



180
employees



6
sites



30%
growth/year

1. INTRODUCTION: LASEA GROUP



1.INTRODUCTION: LASEA GROUP LOCATIONS



Countries where
we have installed
machines



CohPros



Rainford Precision



LAS Photonics

Raymax

► Sydney

BEAMS

► Tokyo

LASEA
Belgium Liège
(Headquarters)



OPTEC
Mons



LASEA France
Bordeaux



LASER
CHEVAL
France
Besançon



LASEA
Switzerland
Biel



LASEA USA
Optec LLC
San Diego



1. INTRODUCTION: 4 STRATEGIC MARKETS



LUXURY



MEDICAL



ELECTRONICS



RESEARCH

1. INTRODUCTION: 4 STRATEGIC MARKETS



LUXURY



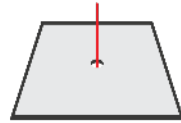
MEDICAL



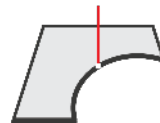
ELECTRONICS



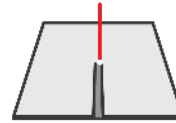
RESEARCH



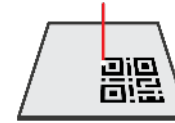
DRILLING



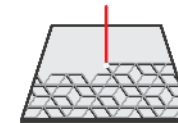
CUTTING



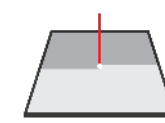
ENGRAVING



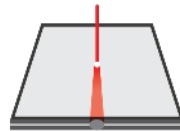
MARKING



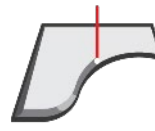
TEXTURING



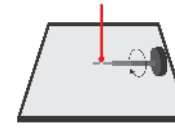
THIN FILM REMOVAL



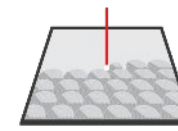
WELDING



CHAMFERING



TURNING



PERFORATION

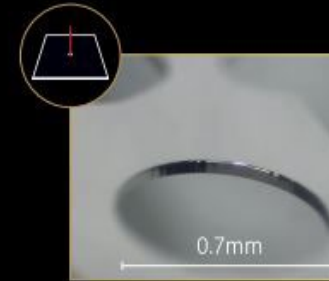
1. INTRODUCTION: 4 STRATEGIC MARKETS



LUXURY



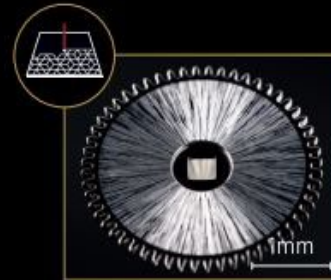
GRAVING



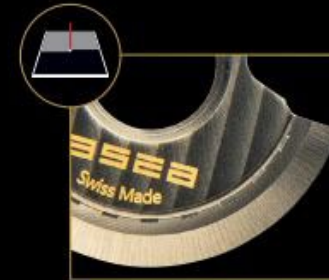
DRILLING



CUTTING



TEXTURATION



THIN FILM
REMOVAL



CHANFERING



MARKING

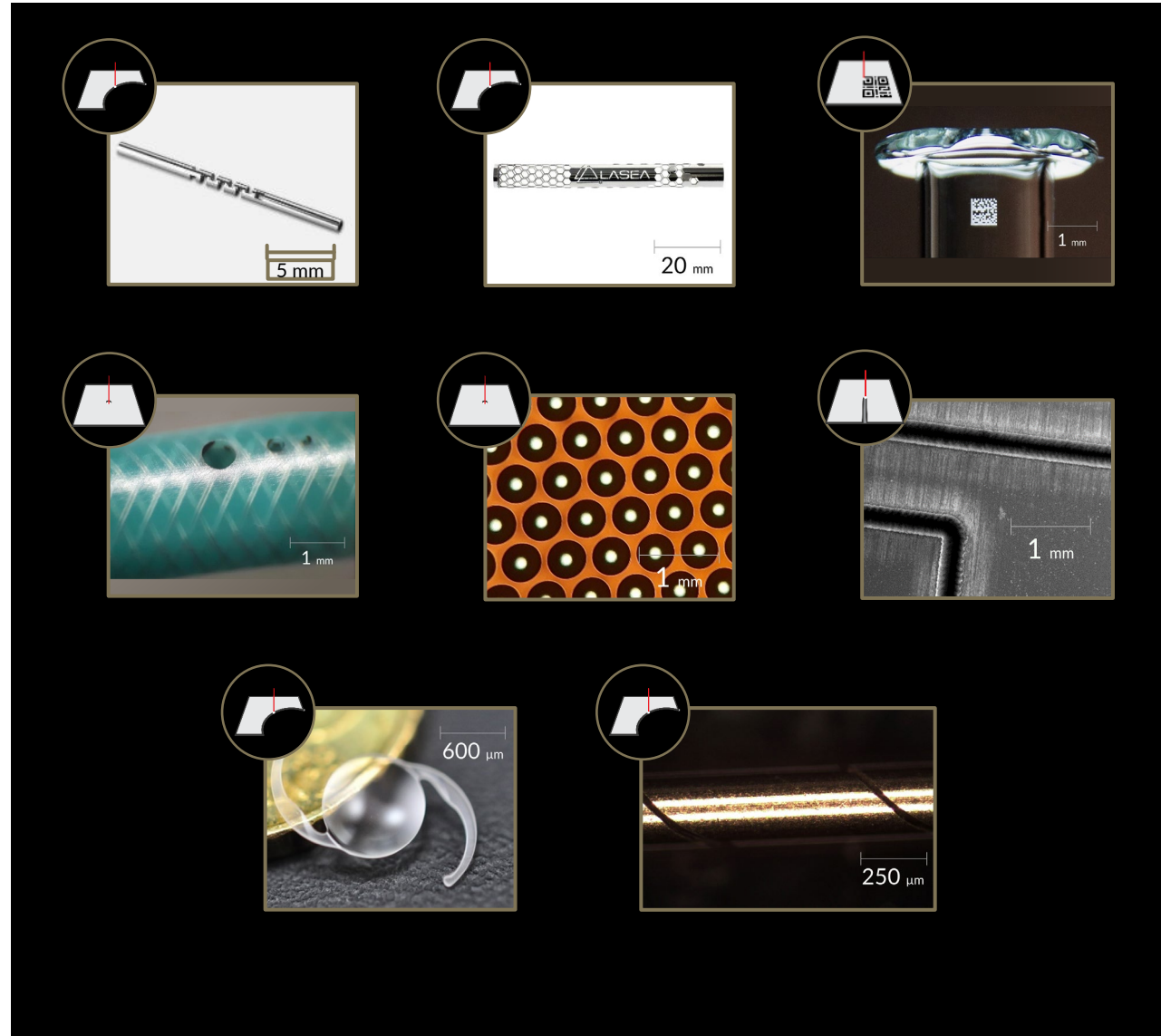


TURNING



WELDING

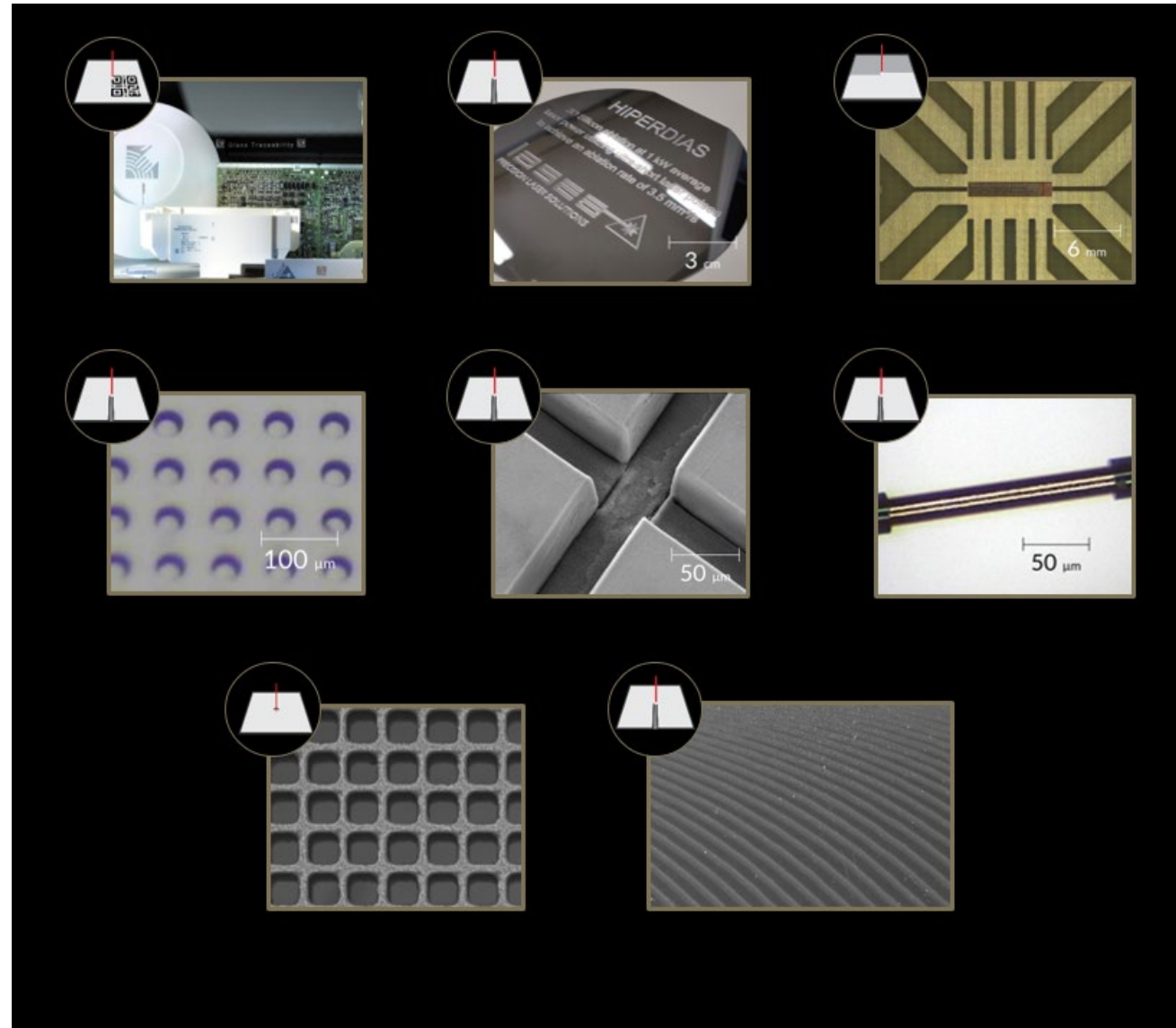
INTRODUCTION: 4 STRATEGIC MARKETS



1. INTRODUCTION: 4 STRATEGIC MARKETS



ELECTRONICS

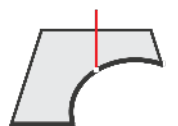


1. INTRODUCTION: 4 STRATEGIC MARKETS

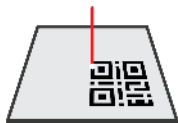


User case: production of isolated circuits on a foil for Morrow

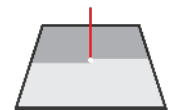
ELECTRONICS



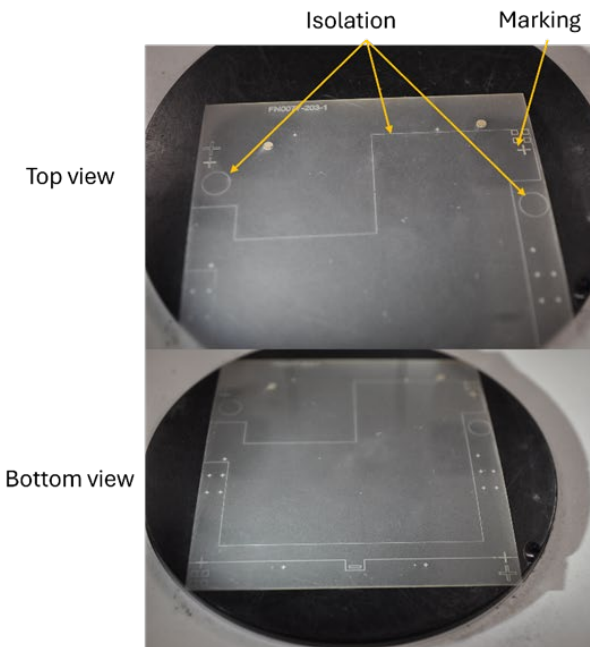
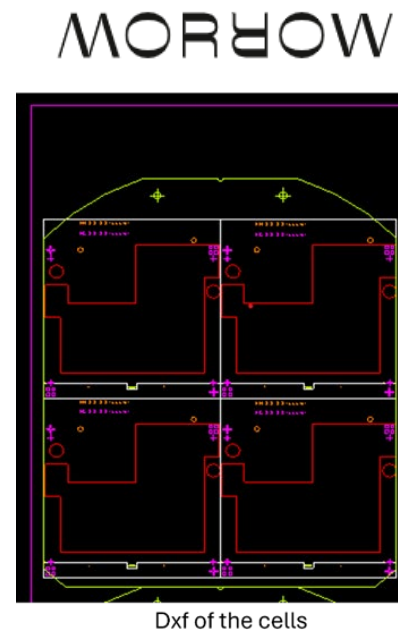
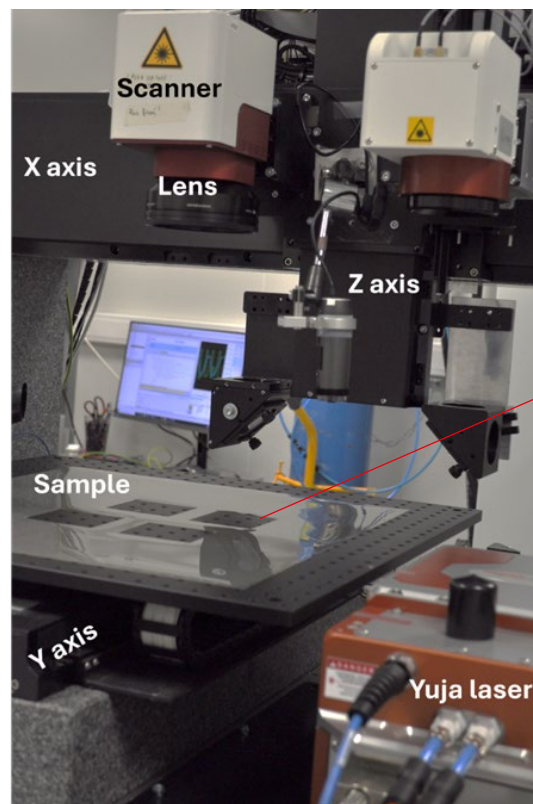
CUTTING



MARKING



THIN FILM REMOVAL



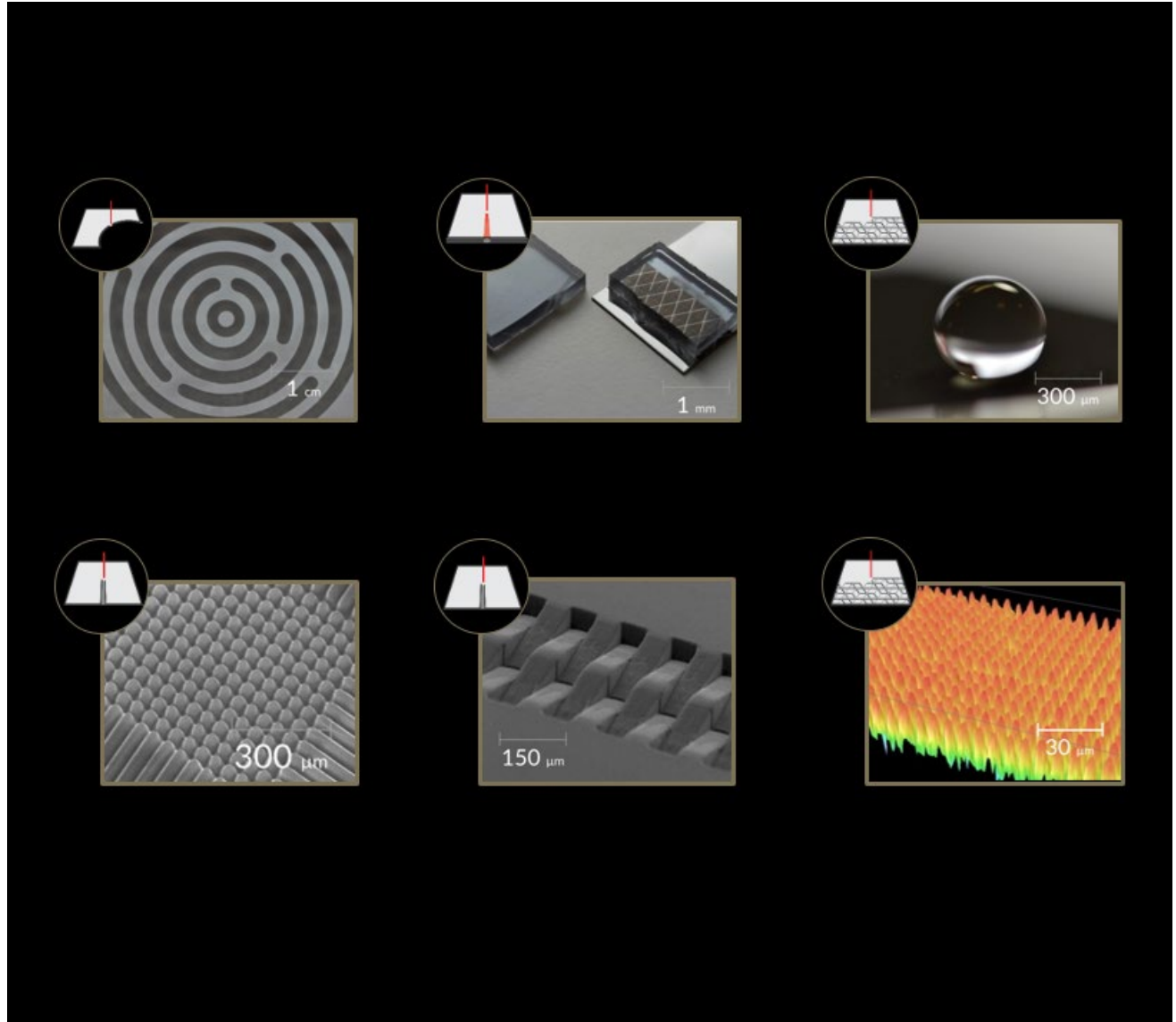
Proof of concept: small production to evaluate:

- ✓ Quality
- ✓ Repetability

1. INTRODUCTION: 4 STRATEGIC MARKETS



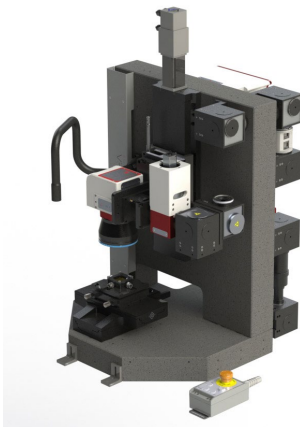
RESEARCH



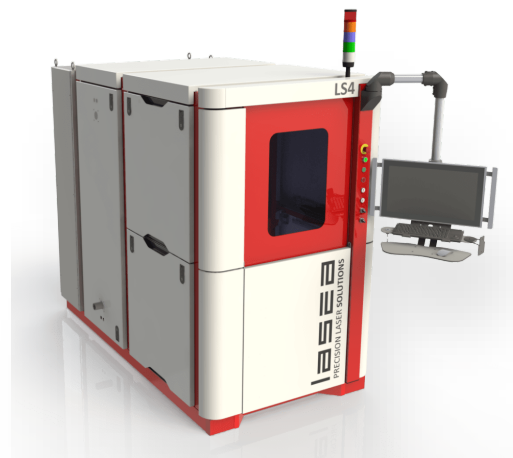
2. LASER MACHINES

Wide range of workstations: a solution for each application

LS-LAB



LS4



Custom machines



LS4-P



New product: LASEA neo

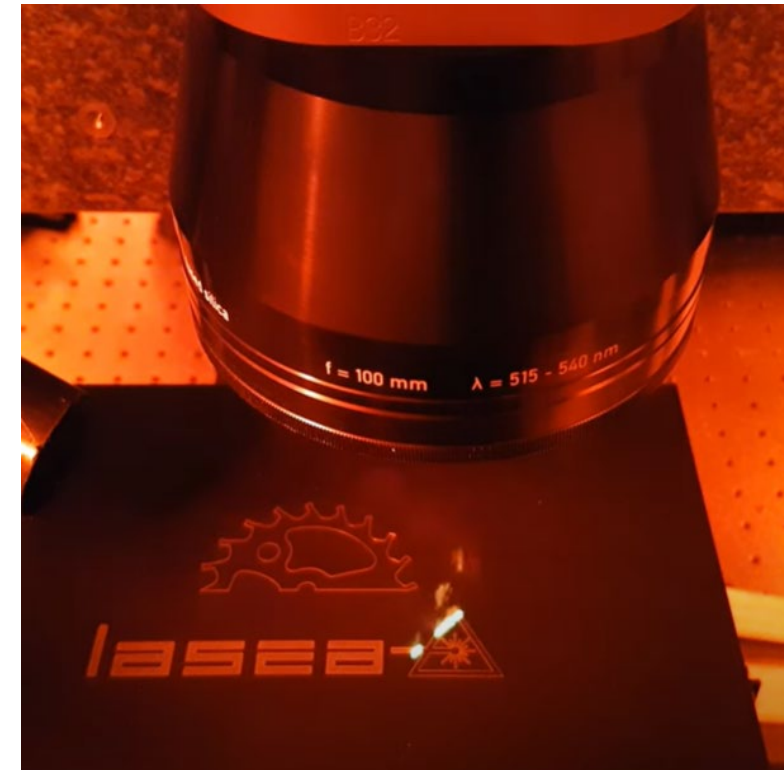
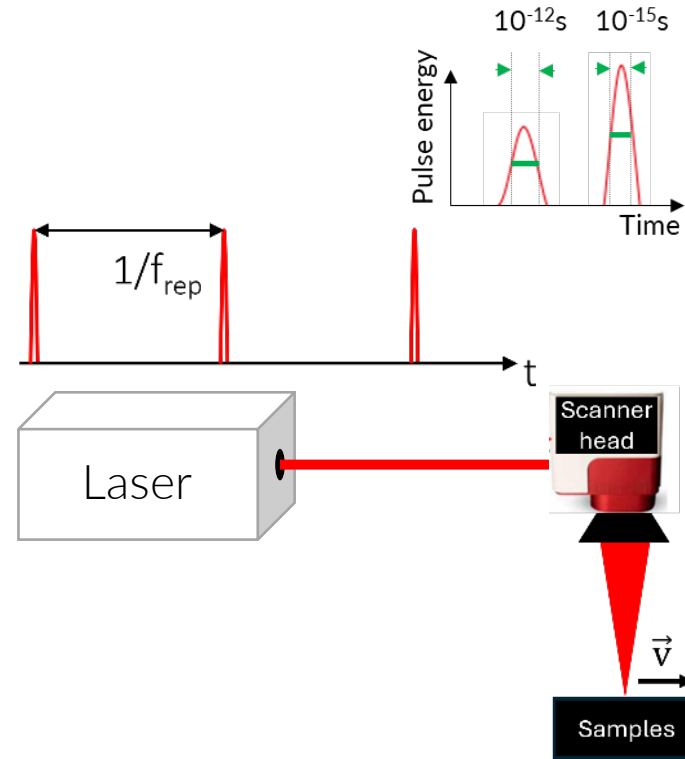


2. LASER MACHINES

Ultrafast lasers: picosecond or femtosecond pulse duration

- Wide range of accessible parameters for each process to develop:

- Laser parameters (i.e. Pulse energy and frequency f_{rep})
- Engraving parameters (i.e. Scanning speed $\vec{v}$)

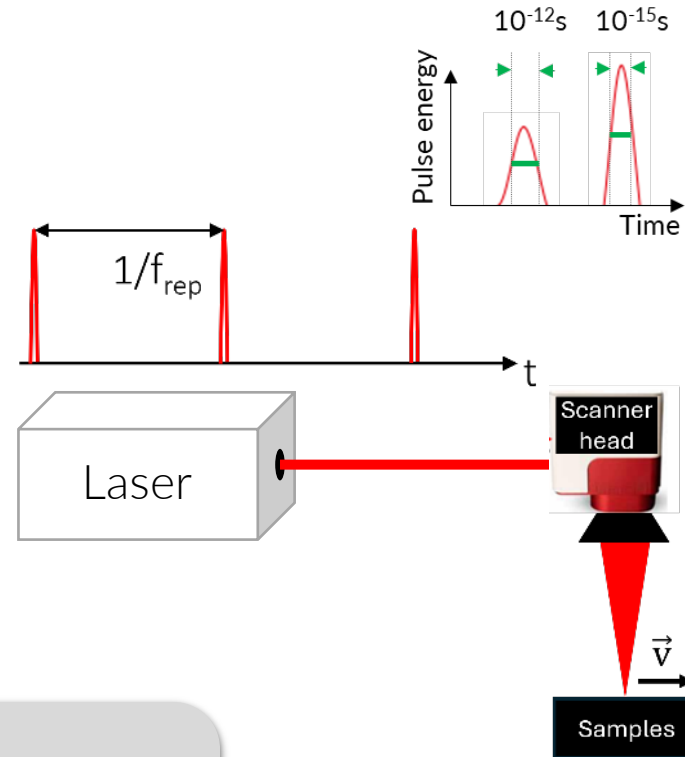


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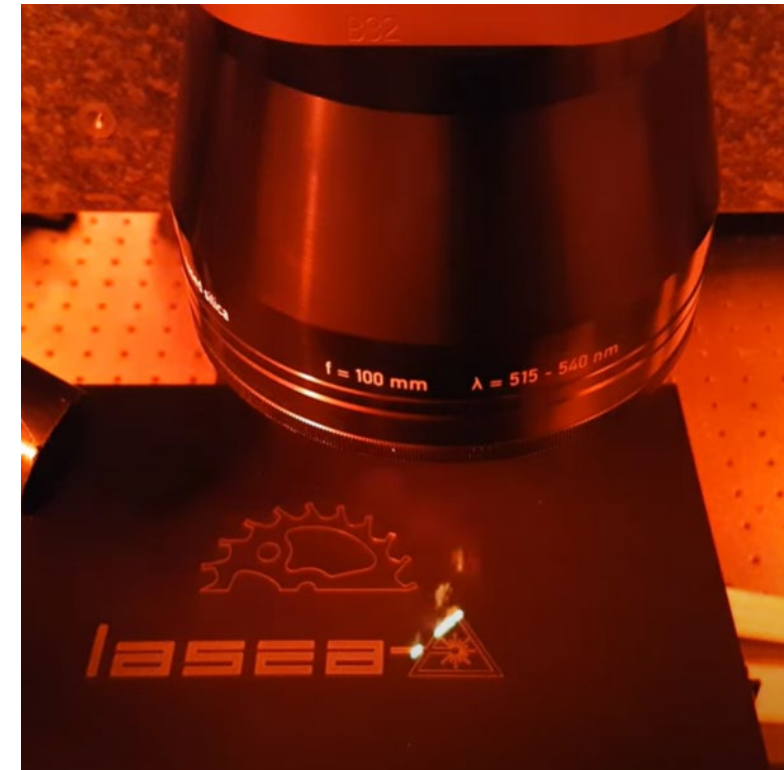
- Laser parameters (i.e. Pulse energy and frequency f_{rep})
- Engraving parameters (i.e. Scanning speed $\vec{v}$)



- Advantage of ultrafast lasers:

- No thermal damage

- High quality
- Excellent repeatability
- Wide range of materials that can be processed



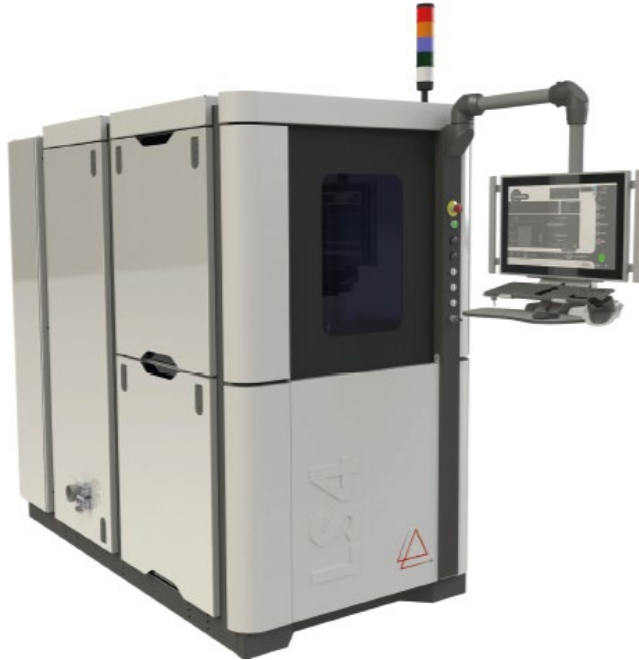
2. LASER MACHINES

Wide range of workstations: a solution for each application

Flexibility : One machine to cover all the applications

From cutting to texturing or engraving

LS4 & LS4-P

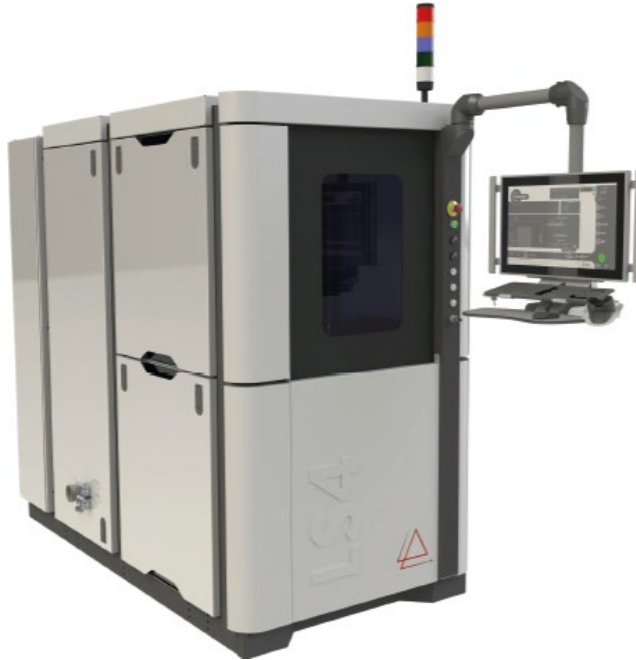


2. LASER MACHINES

Wide range of workstations: a solution for each application



LS4 & LS4-P



Flexibility : One machine to cover all the applications

From cutting to texturing or engraving

Single or multi-wavelength machines / Single or multi-laser source machines

From deep UV (Excimer) to far IR (CO2)

2. LASER MACHINES

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LS4 & LS4-P



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3 to 5 axes

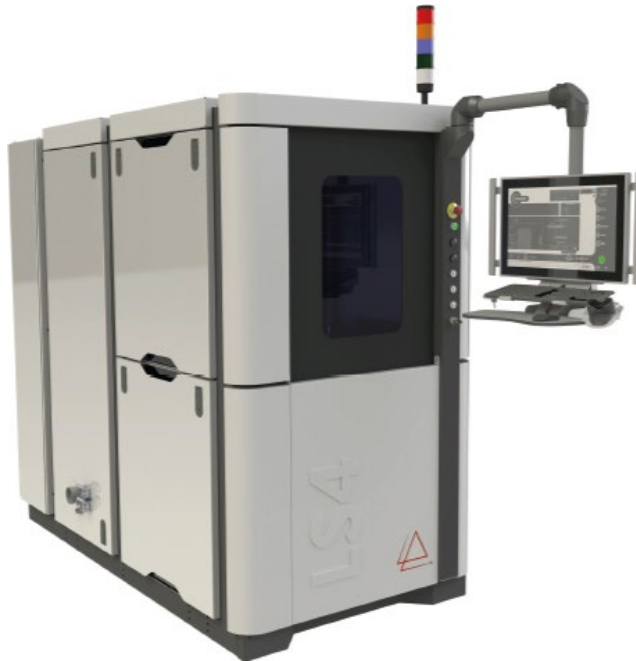
Automated solutions for 24/7 production

2. LASER MACHINES

Wide range of workstations: a solution for each application



LS4 & LS4-P



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Automated solutions for 24/7 production

Needs of the industry:

- Quality
- Accuracy
- Productivity
- Flexible/automated

2. LASER MACHINES

Wide range of workstations: a solution for each application

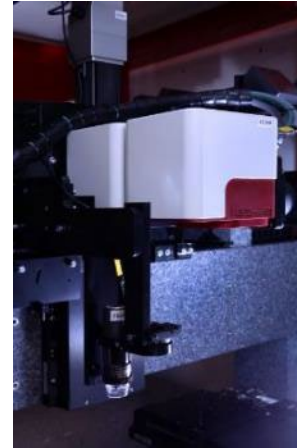


New product: LASEA neo



Mutliheads machines

Two heads on one axis/Two heads on two axes



2. LASER MACHINES

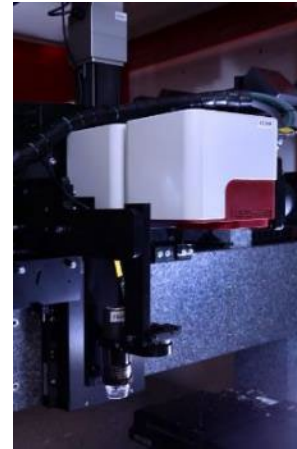
Wide range of workstations: a solution for each application

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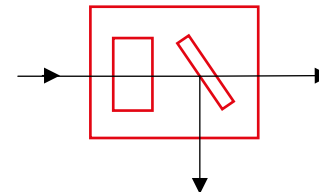
Two heads on one axis/Two heads on two axes



Increased productivity



Beam divided in two beams- One beam/Heads



Polarizing optics

3.FUTURE: AI PREDICTIONS: ENHANCE PRODUCTIVITY AND AUTOMATION



Optimal process development for each application:

Quality and time
criteria



...



3.FUTURE: AI PREDICTIONS: ENHANCE PRODUCTIVITY AND AUTOMATION

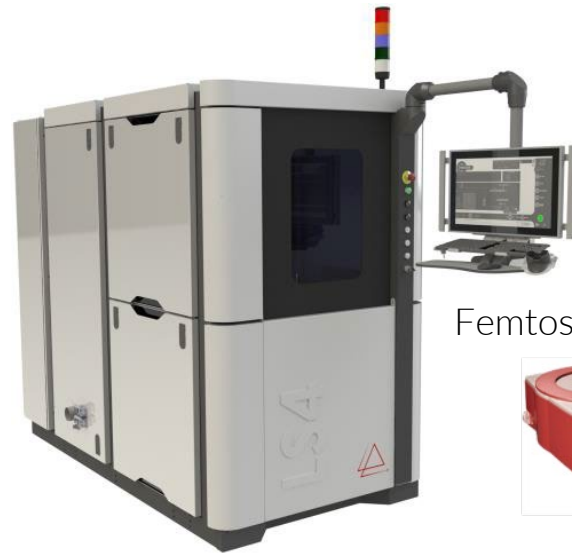
Optimal process development for each application:

Quality and time
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Laser
parameters

Engraving
parameters

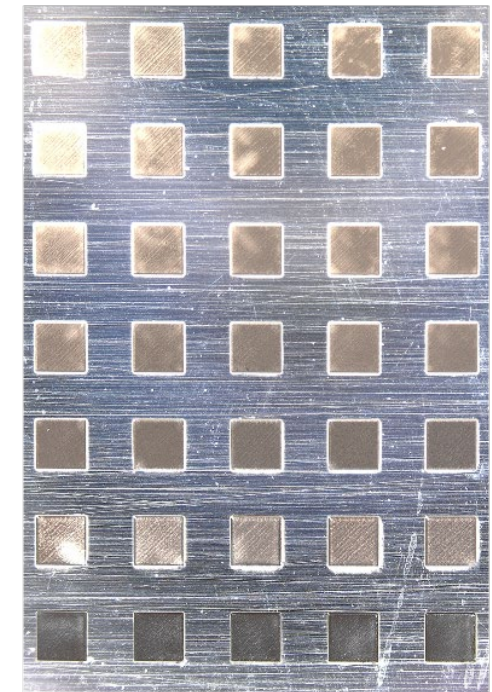


Femtosecond laser



1.Test matrix

Scanning speed ↑



→ Pulse energy

3.FUTURE: AI PREDICTIONS: ENHANCE PRODUCTIVITY AND AUTOMATION

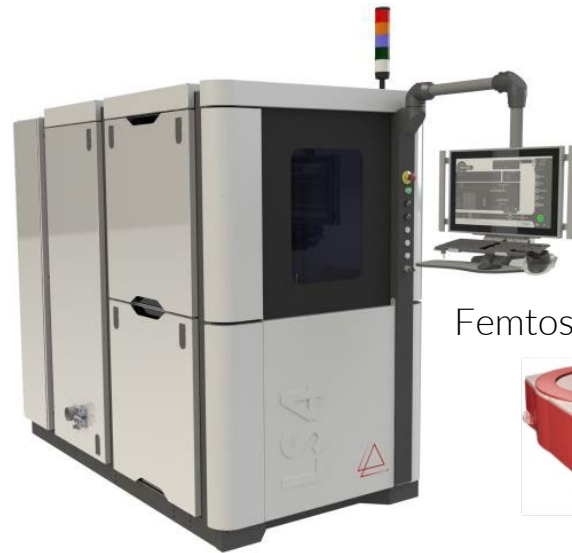
Optimal process development for each application:

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Laser
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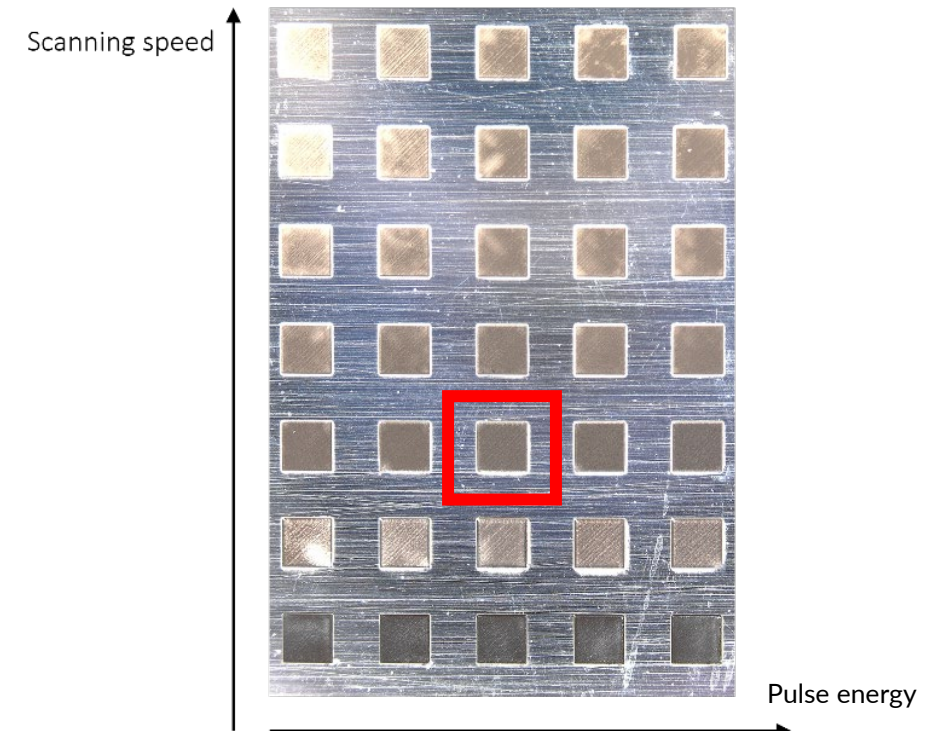
Engraving
parameters



Femtosecond laser



2. Identify good parameters



3.FUTURE: AI PREDICTIONS: ENHANCE PRODUCTIVITY AND AUTOMATION

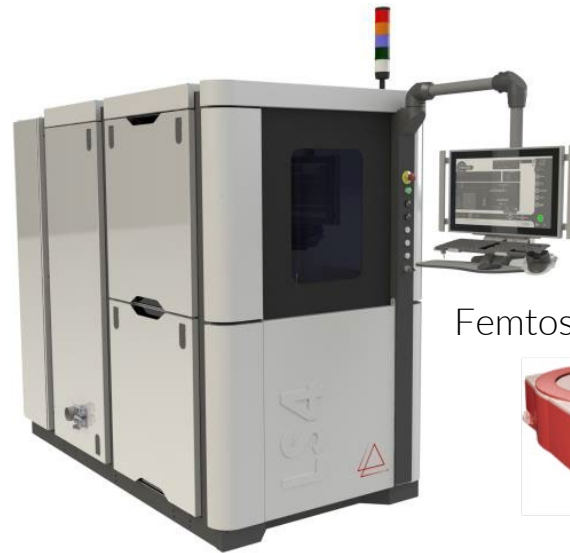
Optimal process development for each application:

Quality and time
criteria



Laser
parameters

Engraving
parameters



Femtosecond laser



3. Test & adapt to the specific
application



Finding optimal process
is time, samples, and
personnel consuming

3.FUTURE: AI PREDICTIONS: ENHANCE PRODUCTIVITY AND AUTOMATION



Optimal process development for each application: AI prediction of optimal laser parameters sets for several materials



EP 3 743 236 B1

US12 032 878

Goals:

- Avoid the research phase of parameters for any kind of different materials
- To have a model easy to adapt to a new material and/or to a different machine

3.FUTURE: AI PREDICTIONS: ENHANCE PRODUCTIVITY AND AUTOMATION



Optimal process development for each application: AI prediction of optimal laser parameters sets for several materials



EP 3 743 236 B1

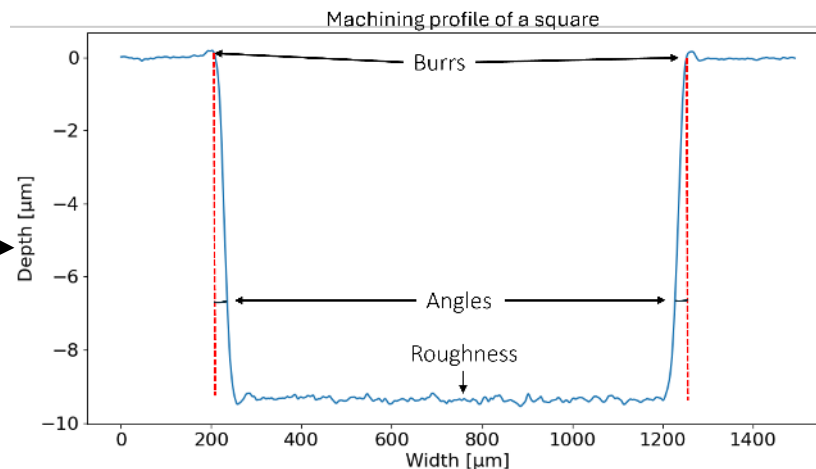
US12 032 878

Goals:

- Avoid the research phase of parameters for any kind of different materials
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Targeted characteristics

- Ablation depth
- Surface roughness S_a
- Burrs
- Angles



3. FUTURE: AI PREDICTIONS: ENHANCE PRODUCTIVITY AND AUTOMATION



Optimal process development for each application: AI prediction of optimal laser parameters sets for several materials



EP 3 743 236 B1

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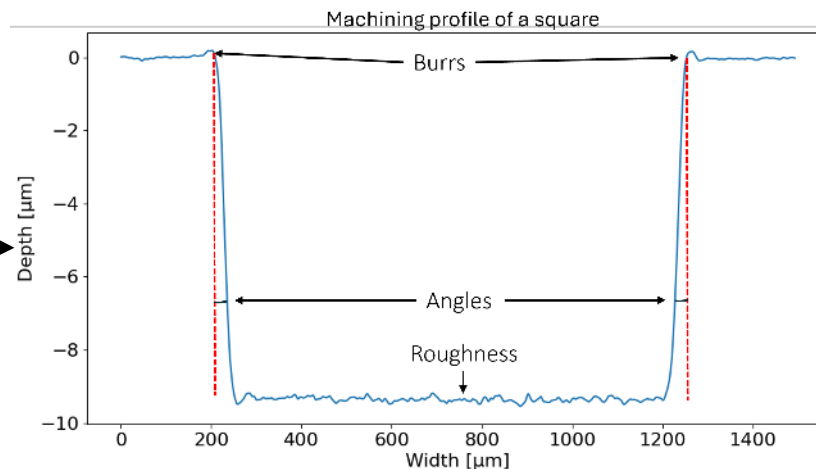
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Targeted characteristics

- Ablation depth
- Surface roughness S_a
- Burrs
- Angles

Predicted engraving parameters:

- Power
- Frequency
- Scanning speed
- Spot diameter
- Hatch pitch
- Number of layers
- Angle between layers



3. FUTURE: AI PREDICTIONS: ENHANCE PRODUCTIVITY AND AUTOMATION

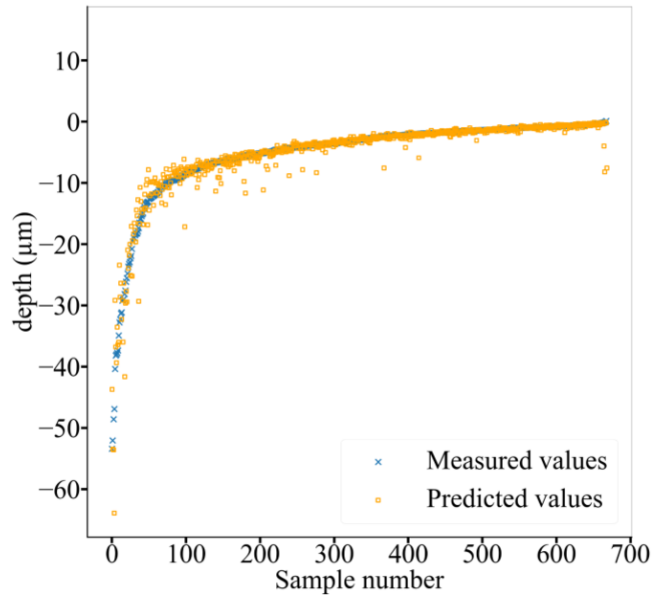


Proof of concept: AI predictions of the ablated depth for several materials

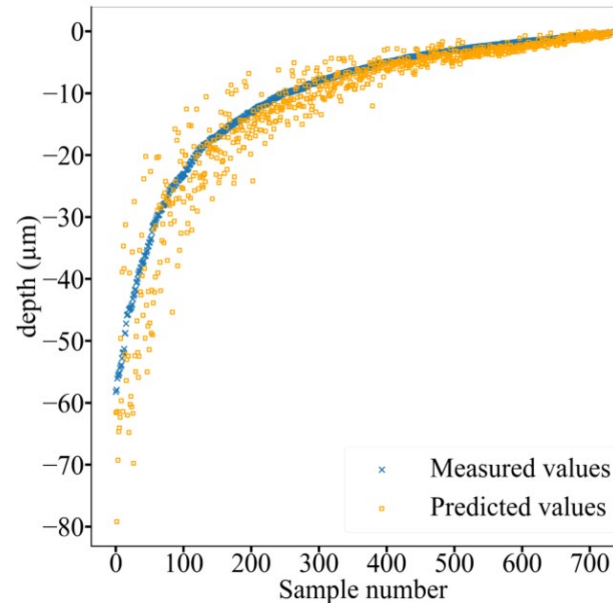
EP 3 743 236 B1

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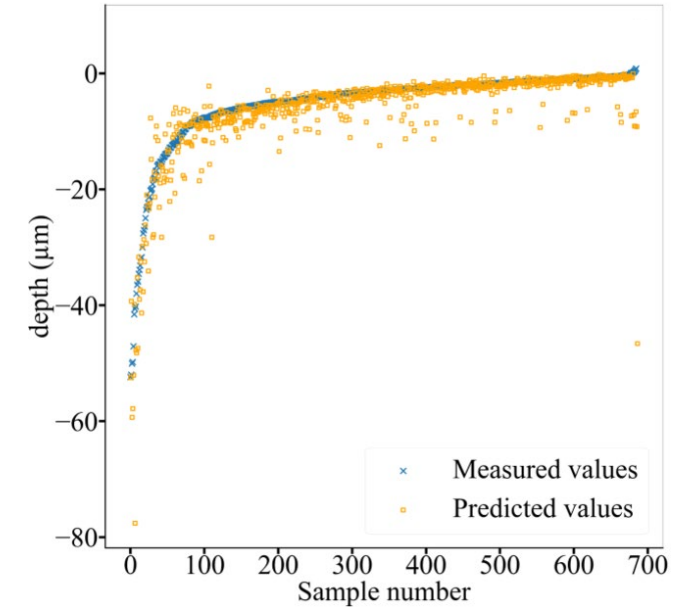
Stainless steel 304



Brass



Titanium



3.FUTURE: AI PREDICTIONS: ENHANCE PRODUCTIVITY AND AUTOMATION

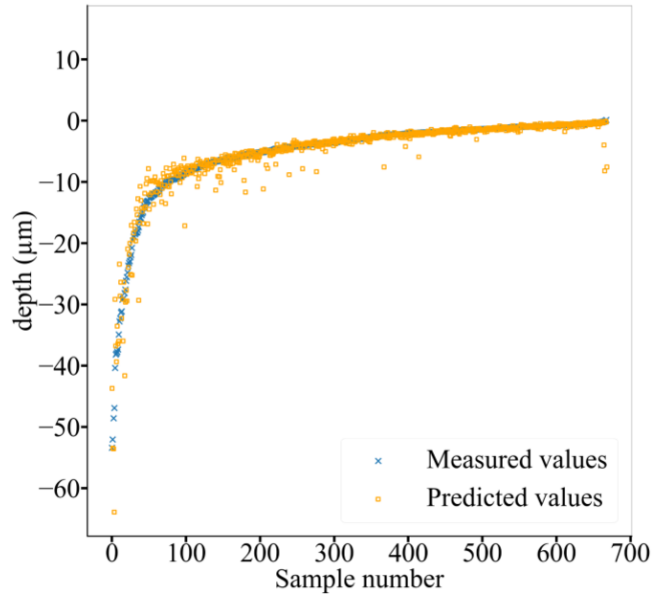


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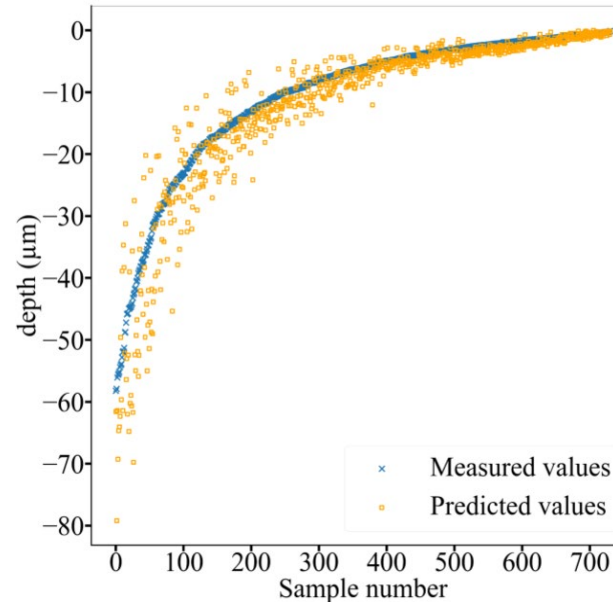
EP 3 743 236 B1

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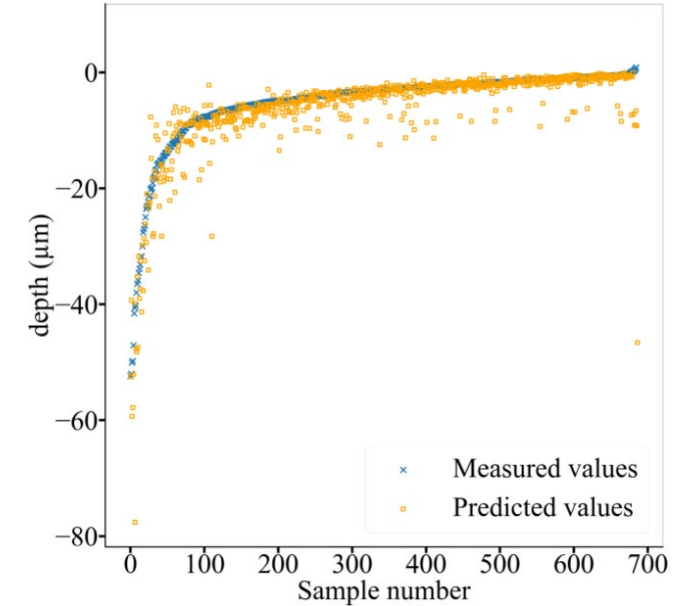
Stainless steel 304



Brass



Titanium



AI predictions of optimal laser parameters will enable productivity improvement by reducing time and material costs, and facilitating machine operation

4. CONCLUSION

LASEA laser machines equipped with ultrafast lasers have:

- Single or multi-wavelength machines
- Single or multi-laser source machines
- Zero taper possibilities
- 3 to 5 axes
- Mutliheads
- Automated solutions

Future: machines equipped with AI prediction of optimal laser parameters

- ✓ Quality
- ✓ Accuracy
- ✓ Productivity
- ✓ Automated
- ✓ Flexibility: covering a lot of applications



Thank you for
your attention

Contact
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Process Engineer
cpetit@lasea.com
LASEA

Supports



Phabulous



PHOTONICS²¹

PHOTONICS PUBLIC PRIVATE PARTNERSHIP